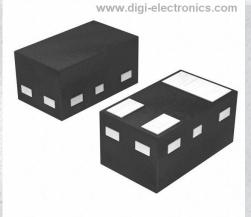


PDTC144VMB,315 Datasheet



DiGi Electronics Part Number	PDTC14
Manufacturer	Nexpe
Manufacturer Product Number	PDTC14
Description	TRANS
Detailed Description	Pre-Bia d 50 V

44VMB,315-DG

ria USA Inc.

44VMB,315

PREBIAS NPN 50V 0.1A 3DFN

ased Bipolar Transistor (BJT) NPN - Pre-Biase 100 mA 230 MHz 250 mW Surface Mount DFN 1006B-3

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
PDTC144VMB,315	Nexperia USA Inc.
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
NPN - Pre-Biased	100 mA
Voltage - Collector Emitter Breakdown (Max):	Resistor - Base (R1):
50 V	47 kOhms
Resistor - Emitter Base (R2):	DC Current Gain (hFE) (Min) @ lc, Vce:
10 kOhms	40 @ 5mA, 5V
Vce Saturation (Max) @ lb, lc:	Current - Collector Cutoff (Max):
150mV @ 500μA, 10mA	1μΑ
Frequency - Transition:	Power - Max:
230 MHz	250 mW
Grade:	Qualification:
Automotive	AEC-Q100
Mounting Type:	Package / Case:
Surface Mount	3-XFDFN
Supplier Device Package:	Base Product Number:
DFN1006B-3	PDTC144

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.21.0075	



PDTC144VMB

NPN resistor-equipped transistor; R1 = 47 kΩ, R2 = 10 kΩRev. 1 — 12 June 2012Product data s

Product data sheet

1. **Product profile**

1.1 General description

NPN Resistor-Equipped Transistor (RET) in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package.

PNP complement: PDTA144VMB.

1.2 Features and benefits

- 100 mA output current capability
- Reduces component count
- Built-in bias resistors
- Reduces pick and place costs

1.3 Applications

- Low-current peripheral driver
- Control of IC inputs

- Simplifies circuit design
- AEC-Q101 qualified
- Leadless ultra small SMD plastic package
- Low package height of 0.37 mm
- Replaces general-purpose transistors in digital applications
- Mobile applications

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	50	V
lo	output current		-	-	100	mA
R1	bias resistor 1 (input)	T _{amb} = 25 °C	33	47	61	kΩ
R2/R1	bias resistor ratio		0.17	0.21	0.26	



PDTC144VMB

NPN resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)		
2	G	GND (emitter)		
3	0	output (collector)	2 Transparent top view SOT883B (DFN1006B-3)	1 R1 R2 sym007

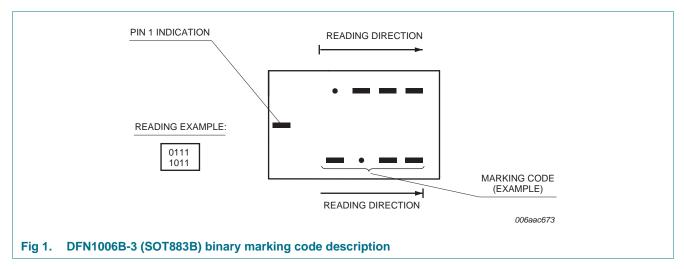
3. Ordering information

Table 3. Ordering information							
Type number Package							
	Name	Description	Version				
PDTC144VMB	DFN1006B-3	Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.37 mm	SOT883B				

4. Marking

Table 4.	Marking codes	
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Type number	Marking code
PDTC144VMB	0011 1110



PDTC144VMB

NPN resistor-equipped transistor; $R1 = 47 k\Omega$, $R2 = 10 k\Omega$

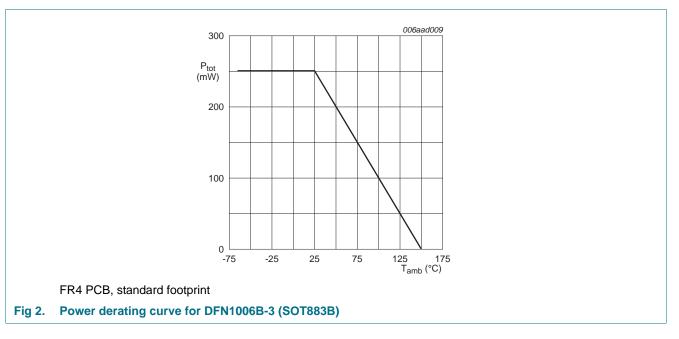
5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	50	V
V _{CEO}	collector-emitter voltage	open base		-	50	V
V _{EBO}	emitter-base voltage	open collector		-	15	V
VI	input voltage	positive		-	40	V
		negative		-	-15	V
lo	output current			-	100	mA
I _{CM}	peak collector current	pulsed; t _p ≤ 1 ms		-	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	<u>[1]</u>	-	250	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



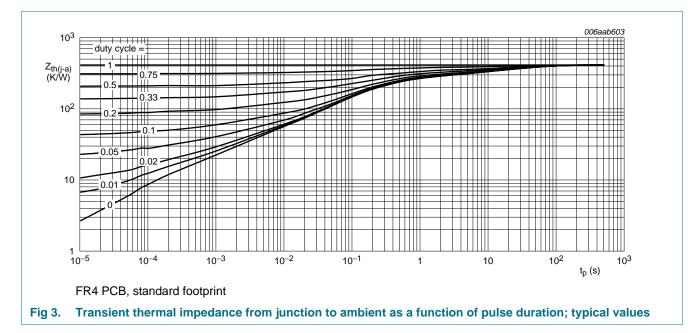
6. Thermal characteristics

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

PDTC144VMB

NPN resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$



7. Characteristics

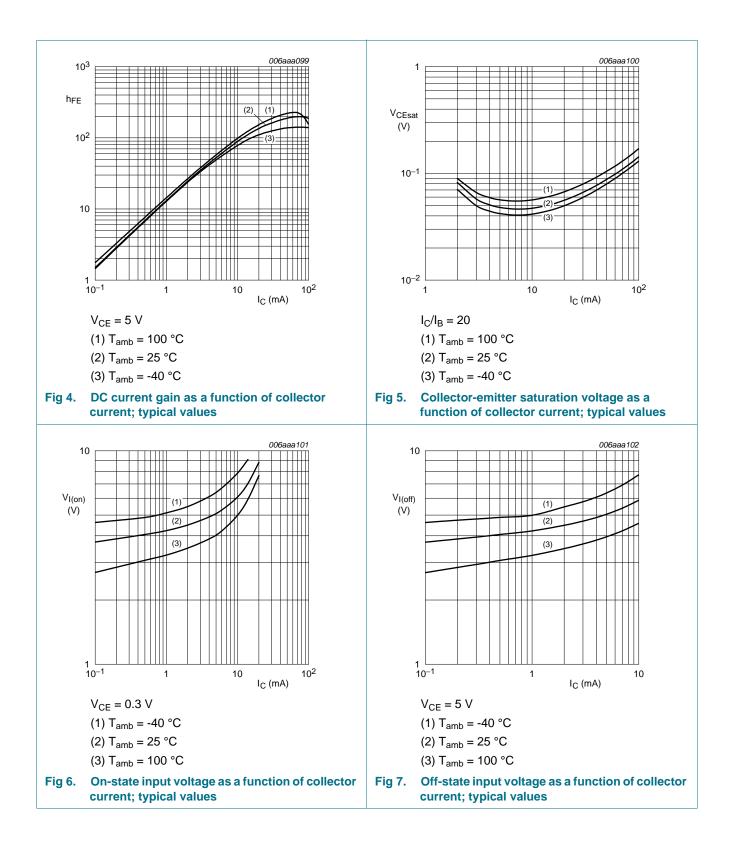
Table 7. Characteristics

Table 7.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	V_{CB} = 50 V; I _E = 0 A; T _{amb} = 25 °C		-	-	100	nA
I _{CEO}	collector-emitter cut-off	$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}; \text{ T}_{amb} = 25 \text{ °C}$		-	-	1	μΑ
	current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}; T_j = 150 \text{ °C}$		-	-	5	μΑ
I _{EBO}	emitter-base cut-off current	V_{EB} = 5 V; I_C = 0 A; T_{amb} = 25 °C		-	-	150	μA
h _{FE}	DC current gain	V_{CE} = 5 V; I _C = 5 mA; T _{amb} = 25 °C		40	-	-	
V _{CEsat}	collector-emitter saturation voltage	I_{C} = 10 mA; I_{B} = 0.5 mA; T_{amb} = 25 °C		-	-	150	mV
V _{I(off)}	off-state input voltage	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 100 \mu\text{A}; \text{ T}_{amb} = 25 ^{\circ}\text{C}$		-	3.1	1	V
V _{I(on)}	on-state input voltage	$V_{CE} = 0.3 \text{ V}; \text{ I}_{C} = 2 \text{ mA}; \text{ T}_{amb} = 25 \text{ °C}$		6	3.8	-	V
R1	bias resistor 1 (input)	T _{amb} = 25 °C		33	47	61	kΩ
R2/R1	bias resistor ratio			0.17	0.21	0.26	
C _C	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = 0 \text{ A}; i_e = 0 \text{ A};$ f = 1 MHz; T _{amb} = 25 °C		-	-	2	pF
f _T	transition frequency	V _{CE} = 5 V; I _C = 10 mA; f = 100 MHz; T _{amb} = 25 °C	<u>[1]</u>	-	230	-	MHz

[1] Characteristics of built-in transistor.

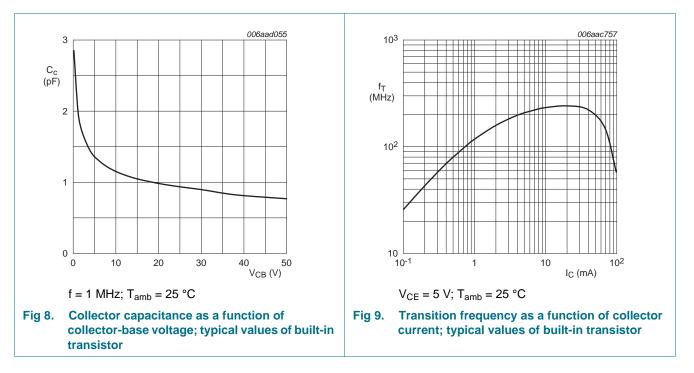
PDTC144VMB

NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 10 k Ω



PDTC144VMB

NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 10 k Ω



8. Test information

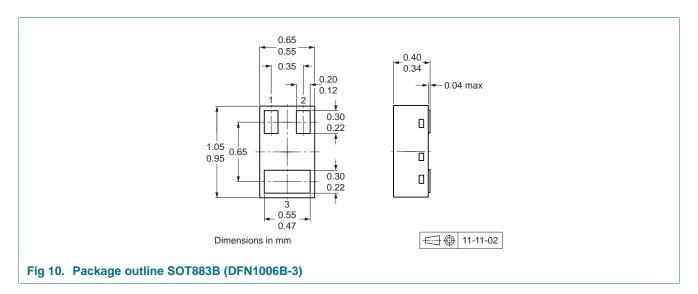
8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

PDTC144VMB

NPN resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

Package outline 9.



10. Soldering

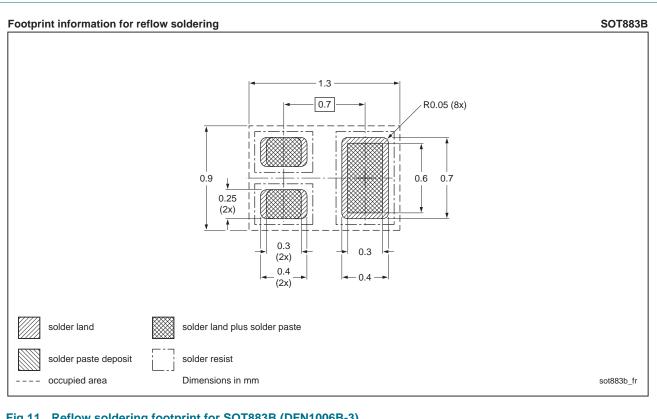


Fig 11. Reflow soldering footprint for SOT883B (DFN1006B-3)

PDTC144VMB **Product data sheet**

PDTC144VMB

NPN resistor-equipped transistor; R1 = 47 k Ω , R2 = 10 k Ω

11. Revision history

Table 8. Revision h	Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes				
PDTC144VMB v.1	20120612	Product data sheet	-	-				

PDTC144VMB

NPN resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

12. Legal information

12.1 Data sheet status

Document status[1] [2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions'

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Product data sheet

PDTC144VMB

PDTC144VMB

NPN resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

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NPN resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

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Date of release: 12 June 2012 Document identifier: PDTC144VMB



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